

#### General purpose; good optimization of properties

Celcon® acetal copolymer grade M90 is a medium viscosity polymer providing optimum performance in general purpose injection molding and extrusion of thin walled tubing and thin gauge film. This grade provides overall excellent performance in many applications. Chemical abbreviation according to ISO 1043-1: POM Please also see Hostaform® C 9021. ECO-B: Celcon® ECO-B POM-Copolymers have the same properties and performance as standard grades but produced with sustainability in mind. Using a mass-balance approach, biogenic feedstocks are used to offset the use of fossil-based raw materials and decrease greenhouse gas emissions. The process is audited and certified according to the ISCC Plus mass balance approach.

#### **Product information**

| Part Marking Code  | POM   |   | ISO 11469   |
|--|---|---|---|
| Rheological properties   |   |   |   |
| Melt volume-flow rate<br>Temperature<br>Load   | 8<br>190<br>2.16  | -   | ISO 1133  |
| Moulding shrinkage, parallel<br>Moulding shrinkage, normal   | 2.0<br>1.9  | %   | ISO 294-4, 2577<br>ISO 294-4, 2577  |
| Typical mechanical properties  |   |   |   |
| Tensile Modulus Yield stress, 50mm/min Yield strain, 50mm/min Flexural Modulus Flexural Stress at 3.5% Compressive stress at 1% strain Shear Modulus Tensile creep modulus, 1h Tensile creep modulus, 1000h Charpy impact strength, 23°C Charpy impact strength, -30°C Charpy notched impact strength, -30°C Izod notched impact strength, -30°C Izod notched impact strength, -30°C | 10<br>2550<br>73<br>26<br>1000<br>2450<br>1350<br>188<br>181<br>6 | MPa<br>%<br>MPa<br>MPa<br>MPa<br>MPa<br>MPa | ISO 527-1/-2 ISO 527-1/-2 ISO 527-1/-2 ISO 527-1/-2 ISO 178 ISO 178 ISO 604 ISO 6721 ISO 899-1 ISO 899-1 ISO 179/1eU ISO 179/1eU ISO 179/1eA ISO 180/1A |
| Thermal properties   |   |   |   |
| Melting temperature, 10°C/min Temp. of deflection under load, 1.8 MPa Temp. of deflection under load, 0.45 MPa Vicat softening temperature, 50°C/h, 50N Ball pressure test Coeff. of linear therm. expansion, parallel Coeff. of linear therm. expansion, normal   |   | °C<br>°C                                    | ISO 11357-1/-3<br>ISO 75-1/-2<br>ISO 75-1/-2<br>ISO 306<br>IEC 60695-10-2<br>ISO 11359-1/-2<br>ISO 11359-1/-2   |

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| Thermal conductivity of melt | 0.155 W/(m K)             | Internal |
|------------------------------|---------------------------|----------|
| Eff. thermal diffusivity     | 4.85E-8 m <sup>2</sup> /s | Internal |
| Spec. heat capacity of melt  | 2210 J/(kg K)             | Internal |

#### Electrical properties

| Volume resistivity  | 8E12 Ohm.m | IEC 62631-3-1 |
|---------------------|------------|---------------|
| Surface resistivity | 3E16 Ohm   | IEC 62631-3-2 |

### Other properties

| Humidity absorption, 2mm | 0.2 %                  | Sim. to ISO 62 |
|--------------------------|------------------------|----------------|
| Water absorption, 2mm    | 0.75 %                 | Sim. to ISO 62 |
| Density                  | 1410 kg/m³             | ISO 1183       |
| Density of melt          | 1200 kg/m <sup>3</sup> | Internal       |

### Injection

| 1                               |             |     |          |
|---------------------------------|-------------|-----|----------|
| Drying Temperature              | 100 - 120   | °C  |          |
| Drying Time, Dehumidified Dryer | 3 - 4       | h   |          |
| Melt Temperature Optimum        | 180         | °C  | Internal |
| Max. mould temperature          | 80 - 120    | °C  |          |
| Back pressure                   | 4           | MPa |          |
| Injection speed                 | slow-medium |     |          |
| Ejection temperature            | 140         | °C  | Internal |
|                                 |             |     |          |

#### Characteristics

Additives Biobased

#### Additional information

Injection molding

Standard reciprocating screw injection molding machines with a high compression screw (minimum 3:1 and preferably 4:1) and low back pressure (0.35 Mpa/50 PSI) are favored. Using a low compression screw (I.E. general purpose 2:1 compression ratio) can result in unmelted particles and poor melt homogeneity. Using a high back pressure to make up for a low compression ratio may lead to excessive shear heating and deterioration of the material.

Melt Temperature: Preferred range 182-199 C (360-390 F). Melt temperature should never exceed 230 C (450 F).

Mold Surface Temperature: Preferred range 82-93 C (180-200 F) especially with wall thickness less than 1.5 mm (0.060 in.). May require mold temperature as high as 120 C (250 F) to reproduce mold surface or to assure minimal molded in stress. Wall thickness greater than 3mm (1/8 in.) may use a cooler (65 C/150 F) mold surface temperature and wall thickness over 6mm (1/4 in.) may use a cold mold surface down to 25 C (80 F). In general, mold surface temperatures lower than 82 C (180 F) may hinder weld line formation and produce a hazy surface or a

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surface with flow lines, pits and other included defects that can hinder part

performance.

Film extrusion Standard extruders with a length to diameter ratio of at least 20:1 are

recommended. The screw should be a high compression ratio of at least 3:1 and preferably 4:1 to assure good melting and melt homogeneity. The design should be approximately 35% each for feed and metering sections with the remaining

30% as the transition zone.

Melt temperature: 160-220 C (320-430 F)

Other extrusion Standard extruders with a length to diameter ratio of at least 20:1 are

recommended. The screw should be a high compression ratio of at least 3:1 and preferably 4:1 to assure good melting and uniform melt homogeneity. The design should be approximately 35% each for the feed and metering sections with the

remaining 30% as transition zone.

Melt temperature 180-220 C (355-430F)

Profile extrusion Standard extruders with a length to diameter ratio of at least 20:1 are

recommended. The screw should be a high compression ratio of at least 3:1 and preferably 4:1 to assure good melting and melt homogeneity. The design should be approximately 35% each for feed and metering sections with the remaining

30% as the transition zone.

Melt temperature: 180-220 C (360-430 F).

Sheet extrusion Standard extruders with a length to diameter ratio of at least 20:1 are

recommended. The screw should be a high compression ratio (at least 3:1 and preferably 4:1) to assure good melting and uniform melt homogeneity. The screw design should be approximately 35% each for the feed and metering sections with

the remaining 30% as the transition zone.

Melt temperature 180-190 C (355-375 F).

Blow molding Consult product information services.

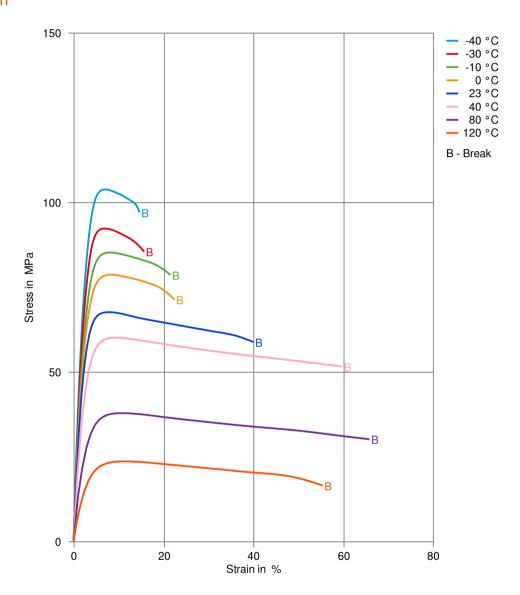
Calandering Consult product information services.

Compression molding Consult product information services.

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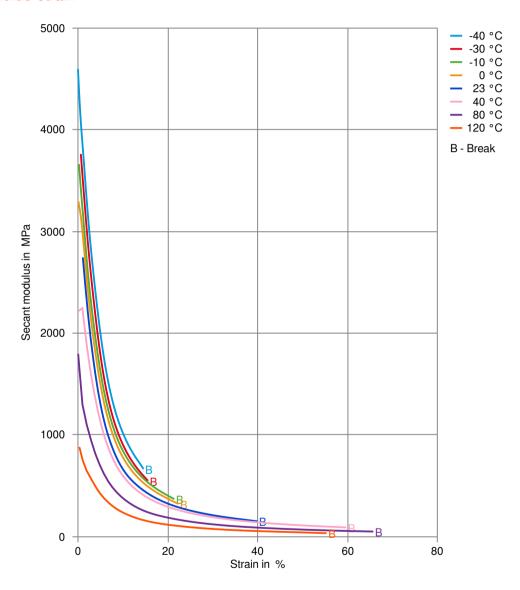
#### Stress-strain



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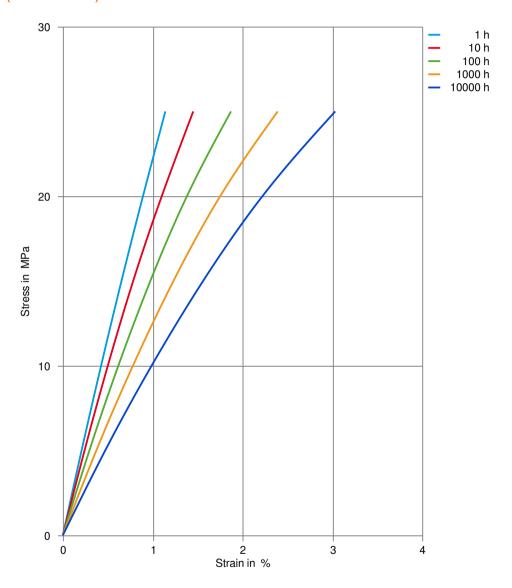
#### Secant modulus-strain



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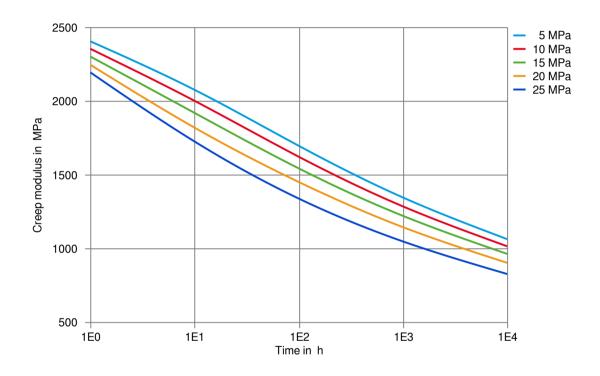
### Stress-strain (isochronous) 23°C



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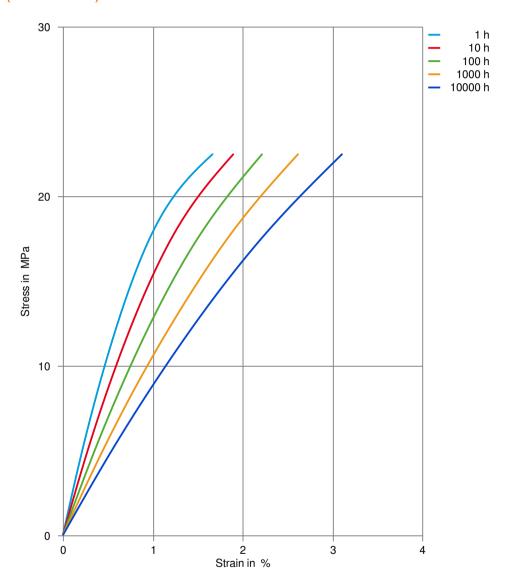
Creep modulus-time 23°C



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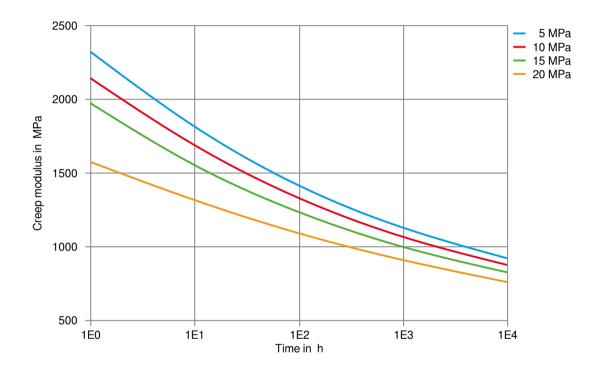
### Stress-strain (isochronous) 40°C



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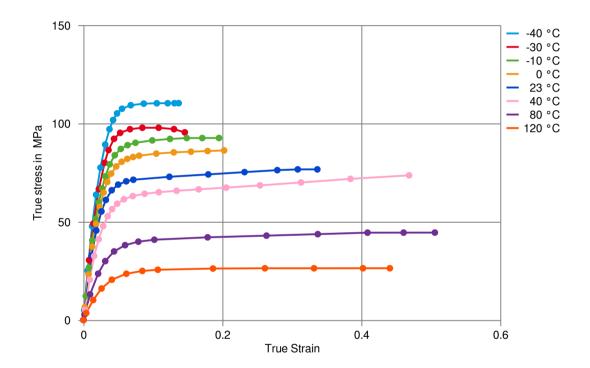
Creep modulus-time 40°C



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#### True stress-strain



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#### **Processing Texts**

Pre-drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

Injection molding

Standard reciprocating screw injection molding machines with a high compression screw (minimum 3:1 and preferably 4:1) and low back pressure (0.35 Mpa/50 PSI) are favored. Using a low compression screw (I.E. general purpose 2:1 compression ratio) can result in unmelted particles and poor melt homogeneity. Using a high back pressure to make up for a low compression ratio may lead to excessive shear heating and deterioration of the material.

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Injection molding Preprocessing

Drying is generally not required because Celcon® and Hostaform® acetal copolymers are not hydroscopic nor are they degraded by moisture during processing. Excessive moisture can lead to splay (silver streaking) in molded parts. For better uniformity in molding especially when using regrind or material that has been stored in containers open to the atmosphere, recommended drying conditions are 80 C (180 F) for 3hours. Desiccant hopper dryers are not required. Maximum water content = 0.35%

Injection molding Postprocessing

Postprocessing conditioning and moisturizing are not required. It may be necessary to fixture large or complicated parts with varying wall thickness to prevent warpage while cooling to ambient temperature.

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NOTICE TO USERS: Values shown are based on testing of laboratory test specimens and represent data that fall within the standard range of properties for natural material. These values alone do not represent a sufficient basis for any part design and are not intended for use in establishing maximum, minimum, or ranges of values for specification purposes. Colourants or other additives may cause significant variations in data values. Properties of moulded parts can be influenced by a wide variety of factors including, but not limited to, material selection, additives, part design conditions and environmental exposure. Other than those products expressly identified as medical grade (including by MT® product designation or otherwise), Celanese's products are not intended for use in medical or dental implants. Regardless of any such product designation, any determination of the suitability of a particular material and part design for any use contemplated by the users and the manner of such use is the sole responsibility of the users, who must assure themselves that the material as subsequently processed meets the needs of their particular product or use. To the best of our knowledge, the information contained in this publication is accurate; however, we do not assume any liability whatsoever for the accuracy and completeness of such information. The information contained in this publication should not be construed as a promise or guarantee of specific properties of our products. It is the sole responsibility of the users to investigate whether any existing patents are infringed by the use of the materials mentioned in this publication, we neither suggest nor guarantee that such hazards are the only ones that exist. We recommend that persons intending to rely on any recommendation or to use any equipment, processing technique or material mentioned in this publication should satisfy themselves that they can meet all applicable safety and health standards. We strongly recommend that users seek and adhere to the manufac

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